



D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

8.2019

### OLED 3.12" - 256x64 dots

Incl. controller SSD1322



#### **Features**

- 3.12" Low-Power OLED
- -40..+80°C (Top.)
- 256x64 dots
- Yellow display
- Incl. controller SSD1322
- SPI, 8-Bit Interface
- Fast response time (10µs) even at -40°C
- ZIFF connection
- 88x28mm outline dimensions

#### **Ordering code**

OLED 3.12" - 256x64 dots, yellow

#### **Accessories**

ZIFF connector 30 pins, 0.5mm pitch, top contact USB-Testboard

**EA W256064-XALG** 

EA WF050-30T EA 9781-1USB





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

### Content

- 1. General Specification
- 2. Contour Drawing & Block Diagram
- 3.Interface Pin Function
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.OLED Lifetime
- 8. Reliability
- 9.Inspection specification
- 10.Precautions in use of OLED Module
- 11.Initialization example
- 12. Application example





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

# 1. General Specification

Item	Dimension	Unit
Dot Matrix	256 x 64 Dots	_
Module dimension	88.0 × 27.8 × 2.05 (mm)	mm
Active Area	76.778×19.178 (mm)	mm
Pixel Size	0.278×0.278 (mm)	mm
Pixel Pitch	0.3×0.3 (mm)	mm
Display Mode	Passive Matrix	
Display Color	Yellow	
Drive Duty	1/64 Duty	
IC	SSD1322	





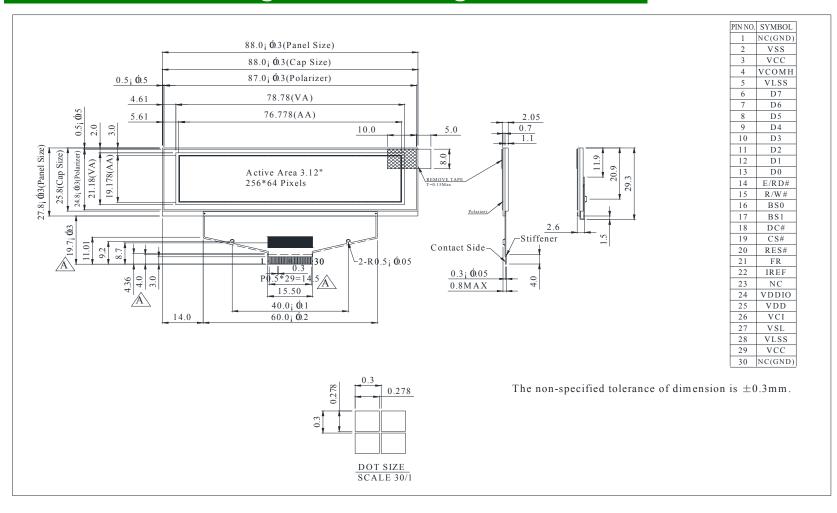
D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

## Counter Drawing & Block Diagram







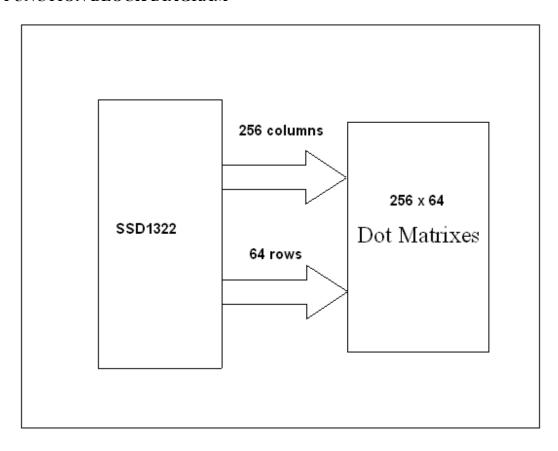
D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

#### FUNCTION BLOCK DIAGRAM







D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

# Interface Pin Function

Pin	Symbol	I/O	Function
Power	Supply		
26	VCI	P	Power Supply for Operation This is a voltage supply pin. It must be connected to external source & always be equal to or higher than VDD & VDDIO.
25	VDD	Р	Power Supply for Core Logic Circuit  This is a voltage supply pin. It can be supplied externally (within the range of 2.4~2.6V) or regulated internally from VCI. A capacitor should be connected between this pin & VSS under all circumstances.
24	VDDIO	Р	Power Supply for I/O Pin This pin is a power supply pin of I/O buffer. It should be connected to VDD or external source. All I/O signal should have VIH reference to VDDIO. When I/O signal pins (BS0~BS1, D0~D7, control signals) pull high, they should be connected to VDDIO.
2	VSS	Р	Ground of Logic Circuit  This is a ground pin. It also acts as a reference for the logic pins. It must be connected to external ground.
3,29	VCC	Р	Power Supply for OLED Panel These are the most positive voltage supply pin of the chip. They must be connected to external source.
5,28	VLSS	Р	Ground of Analog Circuit These are the analog ground pins. They should be connected to VSS externally.
Driver	•		
22	IREF	I	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 10uA.
4	VCOMH	Р	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A tantalum capacitor should be connected between this pin and VSS.
27	VSL	Р	Voltage Output Low Level for SEG Signal This is segment voltage reference pin. When external VSL is not used, this pin should be left open. When external VSL is used, this pin should connect with resistor and diode to ground.





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

Testing Page	ds					
21	FR	0	Frame Frequency Triggering Signal This pin will send out a signal that could be used to identify the driver status. Nothing should be connected to this pin. It should be left open individually.			
16	BS0	I	Communicating Protocol Select These pins are MCU interface select table:	tion input.	See the fo	ollowing
				BS0	BS1	
			3-wire SPI	1	0	
			4-wire SPI	0	0	
			8-bit 68XX Parallel	1	1	
			8-bit 80XX Parallel	0	1	
17	BS1					
20	RES#	I	Power Reset for Controller and L This pin is reset signal input. When of the chip is executed.		low, initiali	zation
19	CS#	ı	Chip Select			
19	00#	'	This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.			
18	D/C#	I	Data/Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the			
14	E/RD#	I	Timing Characteristics Diagrams.  Read/Write Enable or Read  This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low.  When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.  When serial mode is selected, this pin must be connected to			
15	R/W#	I	VSS.  Read/Write Select or Write  This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode.			





Zeppelinstrasse 19 D-82205 Gilching Fon +49-8105-778090 info@lcd-module.de <a href="http://www.lcd-module.de">http://www.lcd-module.de</a>

			When 80XX interface mode is selected, this pin will be the
			Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
			When serial mode is selected, this pin must be connected to VSS.
6~13	D7~D0	I/O	Host Data Input/Output Bus
			These pins are 8-bit bi-directional data bus to be connected to
			the microprocessor's data bus. When serial mode is selected,
			D1 will be the serial data input SDIN and D0 will be the serial
			clock input SCLK.
			Unused pins must be connected to VSS except for D2 in serial mode.
December			mode.
Reserve	T	T	
23	N.C.	-	Reserved Pin
			The N.C. pin between function pins are reserved for compatible
			and flexible design.
1,30	N.C.	-	Reserved Pin (Supporting Pin)
	(GND)		The supporting pins can reduce the influences from stresses on
			the function pins. These pins must be connected to external
			ground.





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

### 4. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Operation	VCI	-0.3	4	V	1, 2
Supply Voltage for Logic	VDD	-0.5	2.75	V	1, 2
Supply Voltage for I/O Pins	VDDIO	-0.5	VCI	V	1, 2
Supply Voltage for Display	VCC	-0.5	20	V	1, 2
Operating Temperature	TOP	-40	80	°C	-
Storage Temperature	TSTG	-40	80	°C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

# 5. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Operation	VCI	Note	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	_	14	14.5	15	<b>\</b>
High Level Input	VIH	_	0.8×V <sub>DDIO</sub>	_	$V_{DDIO}$	V
Low Level Input	VIL	_	0	_	0.2×V <sub>DDIO</sub>	V
High Level Output	VOH	_	0.9×V <sub>DDIO</sub>	_	$V_{DDIO}$	V
Low Level Output	VOL	_	0	_	0.1×V <sub>DDIO</sub>	V
50% Check Board operating	VCC =14.5V	23	25	32	mA	

Note: Supply Voltage for Logic = VDD core power supply can be regulated from VCI.





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

## 6. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V)θ		160			deg
	(Η)φ		160			deg
Contrast Ratio	CR	Dark	2000:1		_	_
Response Time	T rise	_		10		μs
	T fall	_		10		μs
Display with 50% check	Roard Bri	ghtness	100	120		cd/m2
CIEx(Yellow)		(CIE1931)	0.45	0.47	0.49	
CIEy(Yellow)		(CIE1931)	0.48	0.50	0.52	

### 7. OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value	30,000 Hrs	50,000 Hrs	Note

#### Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

## 8. Reliability

Environmental Test						
Test Item	Content of Test	Test Condition	Applicable Standard			
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80□ 240hrs	_			
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40□ 240hrs				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80□ 240hrs				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40□ 240hrs				
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60□,90%RH 240hrs				
Temperature Cycle	Endurance test applying the low and high temperature cycle.  -40	-40□/80□ 100 cycles	_			
Mechanical Tes	et					
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr				
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction				
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs				
Others						
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time				

<sup>\*\*\*</sup> Supply voltage for OLED system =Operating voltage at 25°C





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

#### Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

#### **Evaluation criteria**

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

#### **APPENDIX:**

#### **RESIDUE IMAGE**

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

# 9. Inspection specification

NO	Item	Criterion			AQL
01	Electrical Testing	<ul> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 OLED viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> <li>2.1 White and black spots on display □0.25mm, no more than</li> </ul>			0.65
02	Black or white spots on OLED	three white or black spots 2.2 Densely spaced: No m 3mm.	present.		2.5
03	OLED black spots, white spots, contamina tion (non-displ ay)	3.1 Round type : As following drawing Φ=( x + y ) / 2  X Y Y	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2	2.5
		3.2 Line type : (As following			
		Length	Width	Acceptable Q TY	
			W≦0.02	Accept no dense	2.5
		<u>L≦3.0</u> L≤3.5	0.02 < W ≤ 0.03	2	2.5
		L≦2.5	0.03 <w≦0.05 0.05<w< td=""><td>As round turns</td><td></td></w<></w≦0.05 	As round turns	
			VV >C∪.∪ 1	As round type	
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size $\Phi$ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total O TY	Acceptable Q TY Accept no dense 3 2 0	2.5





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 OLED b	lack spots, white spot	ts, contamination	
			y: Chip width z: 0 t: Glass thickness a: pth:		
		6.1 General glass chi 6.1.1 Chip on panel s		ween panels:	
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x≦1/8a	2.5
	glass	1/2t <z≦2t< td=""><td>Not exceed 1/3k</td><td>x≦1/8a</td><td></td></z≦2t<>	Not exceed 1/3k	x≦1/8a	
		6.1.2 Corner crack:  Z: Chip thickness  Z≤1/2t	y: Chip width Not over viewing area	x: Chip length x≦1/8a	
		1/2t <z≦2t< td=""><td>Not exceed 1/3k</td><td>x≦1/8a</td><td></td></z≦2t<>	Not exceed 1/3k	x≦1/8a	
		⊙ If there are 2 or mo	ore chips, x is the total	l length of each chip.	





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

NO	Item	Criterion	AQL			
	Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:					
		$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$				
		6.2.2 Non-conductive portion:				
06	Glass crack	y 12 X X	2.5			
		y: Chip width x: Chip length z: Chip thickness				
		$y \le L$ $x \le 1/8a$ $0 < z \le t$				
		<ul> <li>If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal</li> </ul>				
		specifications.				
		⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged.				
		6.2.3 Substrate protuberance and internal crack.				
		y: width x: length				
		y ≦ 1/3L				
		y w				





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

NO	Item	Criterion	AQL			
07	Cracked glass	The OLED with extensive crack is not acceptable.				
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> <li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li> <li>9.2 Bezel must comply with job specifications.</li> </ul>				
09	Bezel					
10	PCB、COB	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> </ul>	2.5 2.5 0.65 2.5 2.5 0.65 2.5			
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65			





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

NO	Item	Criterion	AQL
12	General appearance	<ul> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> <li>12.8 Pin type must match type in specification sheet.</li> <li>12.9 OLED pin loose or missing pins.</li> <li>12.10 Product packaging must the same as specified on packaging specification sheet.</li> <li>12.11 Product dimension and structure must conform to product specification sheet.</li> </ul>	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

Check Item	Classification	Criteria					
No Display	Major						
Missing Line	Major						
Pixel Short	Major						
Darker Short	Major						
Wrong Display	Major						
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major						





Zeppelinstrasse 19 D-82205 Gilching Fon +49-8105-778090 info@lcd-module.de <a href="http://www.lcd-module.de">http://www.lcd-module.de</a>

A Normal
B Dark Pixel
C Light Pixel





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

### 10.Precautions in use of OLED Modules

#### Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8)It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9)Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time..
- (10)ELECTRONIC ASSEMBLY has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) ELECTRONIC ASSEMBLY have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, ELECTRONIC ASSEMBLY have the right to modify the version.)

#### 10.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent
  - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent

such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- \* Water
- \* Ketone
- \* Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the





D-82205 Gilching

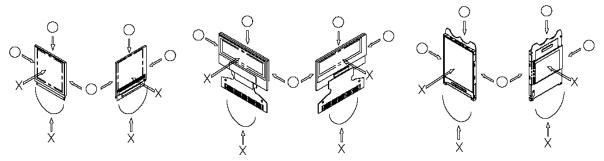
Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.

These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- \* Be sure to make human body grounding when handling OLED display modules.
- \* Be sure to ground tools to use or assembly such as soldering irons.
- \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- \* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
- (11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

#### 10.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from ELECTRONIC ASSEMBLY Technology Inc.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

#### 10.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) When fastening the OLED display module, fasten the external plastic housing section.
- (7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
- \* Connection (contact) to any other potential than the above may lead to rupture of the IC.11.4.

#### Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

#### 10.4. Other Precautions

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- \* Pins and electrodes
- \* Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- \* Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- \* Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.

- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6)Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7)Our company will has the right to upgrade and modify the product function.





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

### 11.Initialization example

```
Global variables
**********************************
uint8_t buf[20];
                          //SPI command buffer
uint8_t buffer[128];
                          //SPI data buffer
const uint8_t lookupval[4] = {0x0,0xF,0xF0,0xFF}; //lookup table
Function name: command
Description: send command via SPI
void command(uint8 t command){
  waitforemptybuffer(); //waits until SPI buffer is empty
  buf[0] = command;
  PORT5.PODR.BIT.B4 = 0; //set D/C# pin low
  R_RSPI0_Send(buf,1); //send buffer via SPI
}
/************************
Function name: data
Description: send data via SPI
void data(uint8 t data){
    buf[0] = data;
  PORT5.PODR.BIT.B4 = 1;  //set D/C# pin high
  R_RSPI0_Send(buf,1); //send buffer via SPI
}
/**********************
Function name: initW256064
Description: Initialization of the display
********************************
void initW256064 (void){
    PORT5.PODR.BIT.B5 = 0;
                          //Reset pin low
                      //100ms delay
  ms_delay(100);
  PORT5.PODR.BIT.B5 = 1;
                         //Reset pin high
  ms_delay(100);
                       //100ms delay
    command(0xFD); //set Command unlock
  data(0x12);
  command(0xAE);
              //set display off
```





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

```
command(0xB3);
                  //set display clock divide ratio...
data(0x91);
                  //...to 135 Frames/sec
command(0xCA);
                  //set multiplex ratio...
data(0x3F);
                  //...to 64-1
command(0xA2);
                  //set display offset
                  //...to 0
data(0x00);
command(0xA1);
                  //start display start line
data(0x00);
                  //...to 0
command(0xA0);
                  //set Re-Map & Dual COM Line Mode
data(0x14);
data(0x11);
command(0xB5);
                  //disable IO intput
data(0x00);
command(0xAB);
                   //function select
data(0x01);
command(0xB4);
                  //enable VSL extern
data(0xA0);
data(0xFD);
command(0xC1);
                  //set contrast current
data(0xFF);
command(0xC7);
                  //set master contrast current
data(0x0F);
  command(0xB8); //set gray scale table
data(0x00);
data(0x00);
data(0x00);
data(0x03);
data(0x06);
data(0x10);
data(0x1D);
data(0x2A);
data(0x37);
data(0x46);
data(0x58);
data(0x6A);
data(0x7F);
data(0x96);
data(0xB4);
command(0xB1);
                  //set phase length
data(0xE8);
```





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

```
command(0xD1);
                     //enhance driving scheme capability
    data(0x82);
    data(0x20);
    command(0xBB);
                     //first pre charge voltage
    data(0x1F);
    command(0xB6);
                     //second pre charge voltage
    data(0x08);
    command(0xBE);
                     //VCOMH
    data(0x07);
    command(0xA9);
                     //no partial mode
    command(0xA6);
                     //set normal display mode
    ms_delay(1); //stabilize VDD
    command(0xAF);
                    //display on
    ms delay(200);
                    //stabilize VDD
}
/*********************************
Function name: initWindow
Description: Initialization of the window in horizontal addressing mode
void initWindow(uint8_t startcol, uint8_t stopcol, uint8_t startrow, uint8_t stoprow){
      command(0x15);
    data(28+startcol);
    data(28+stopcol);
    command(0x75);
    data(startrow);
    data(stoprow);
    command(0x5C);
    ms_delay(50);
}
```





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

```
******************
Function name: sendDataW256064
Description: Sends data to the display (Initialization of the window before sending data to
the display -> initWindow()
Display controller provides 4Bit grayscale -> function only use monochrome data
void sendDataW256064 (const uint8_t *tx_buf, uint16_t tx_num){
      uint16_t i,j,w;
    uint16_t count, totcount;
    uint8_t byte;
    count = 0;
    totcount = 2;
      //convert monochrome pixel data to 4Bit grayscale 0->0000; 1->1111
    for (j=0;j<64;j++){
                                //all 64 rows
            waitforemptybuffer(); //Waits until SPI buffer is empty
        for(i=0;i<32;i++){</pre>
             byte = tx buf[totcount];
                                         //store actual byte
             totcount++;
             for(w=0;w<4;w++){</pre>
                 buffer[count] = lookupval[(byte & 0xC0)>>6];
                 byte = byte << 2;
                 count++;
             }
        }
        PORT5.PODR.BIT.B4 = 1;
                                     //D/C# pin high
        R_RSPI0_Send(&buffer,128); //send data buffer via SPI (one row)
        count = 0;
    }
```

Convertion example of one monochrome data byte (8 pixel) to 4Bit grayscale data:

0x9A					,	1111	0000	0000	1111	1111	0000	1111	0000				
I	1	0	0	1	1	0	1	0	$\rightarrow$	0xF0		0x0	0F	0x	:F0	0x	:F0

2048 data bytes tx\_buf[]  $\rightarrow$  64x128 data bytes buffer[]





D-82205 Gilching

Fon +49-8105-778090

info@lcd-module.de

http://www.lcd-module.de

# 12. Application example

